

## Excellent Integrated System Limited

Stocking Distributor

Click to view price, real time Inventory, Delivery & Lifecycle Information:

[IXYS Corporation](#)

[IXFC16N50P](#)

For any questions, you can email us directly:

[sales@integrated-circuit.com](mailto:sales@integrated-circuit.com)



# PolarHV™ HiPerFET IXFC 16N50P

## Power MOSFET

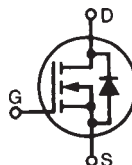
### ISOPLUS220™

(Electrically Isolated Back Surface)

N-Channel Enhancement Mode

Fast Intrinsic Diode

Avalanche Rated



$$V_{DSS} = 500 \text{ V}$$

$$I_{D25} = 10 \text{ A}$$

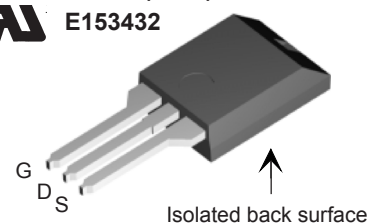
$$R_{DS(on)} \leq 450 \text{ m}\Omega$$

$$t_{rr} \leq 200 \text{ ns}$$

Symbol	Test Conditions	Maximum Ratings	
$V_{DSS}$	$T_J = 25^\circ\text{C}$ to $150^\circ\text{C}$	500	V
$V_{DGR}$	$T_J = 25^\circ\text{C}$ to $150^\circ\text{C}$ ; $R_{GS} = 1 \text{ M}\Omega$	500	V
$V_{GS}$	Continuous	$\pm 30$	V
$V_{GSM}$	Transient	$\pm 40$	V
$I_{D25}$	$T_C = 25^\circ\text{C}$	10	A
$I_{DM}$	$T_C = 25^\circ\text{C}$ , pulse width limited by $T_{JM}$	35	A
$I_{AR}$	$T_C = 25^\circ\text{C}$	10	A
$E_{AR}$	$T_C = 25^\circ\text{C}$	25	mJ
$E_{AS}$	$T_C = 25^\circ\text{C}$	750	mJ
$dv/dt$	$I_S \leq I_{DM}$ , $di/dt \leq 100 \text{ A}/\mu\text{s}$ , $V_{DD} \leq V_{DSS}$ , $T_J \leq 150^\circ\text{C}$ , $R_G = 10 \Omega$	10	V/ns
$P_D$	$T_C = 25^\circ\text{C}$	125	W
$T_J$		-55 ... +150	$^\circ\text{C}$
$T_{JM}$		150	$^\circ\text{C}$
$T_{stg}$		-55 ... +150	$^\circ\text{C}$
$T_L$	1.6 mm (0.062 in.) from case for 10 s	300	$^\circ\text{C}$
$T_{SOLD}$	Plastic body for 10 s	260	$^\circ\text{C}$
$V_{ISOL}$	50/60 Hz, RMS, $t = 1$ , leads-to-tab	2500	V~
$F_c$	Mounting Force	11..65/2.5..15	N/lb
<b>Weight</b>		2	g

ISOPLUS220™ (IXFC)

E153432



G = Gate  
D = Drain  
S = Source

#### Features

- † Silicon chip on Direct-Copper-Bond substrate
- High power dissipation
- Isolated mounting surface
- 2500V electrical isolation
- † Low drain to tab capacitance (<35pF)
- † Low  $R_{DS(on)}$  HDMOS™ process
- † Rugged polysilicon gate cell structure
- † Unclamped Inductive Switching (UIS) rated
- † Fast intrinsic Rectifier

#### Applications

- † DC-DC converters
- † Battery chargers
- † Switched-mode and resonant-mode power supplies
- † DC choppers
- † AC motor control

#### Advantages

- † Easy assembly: no screws, or isolation foils required
- † Space savings
- † High power density
- † Low collector capacitance to ground (low EMI)

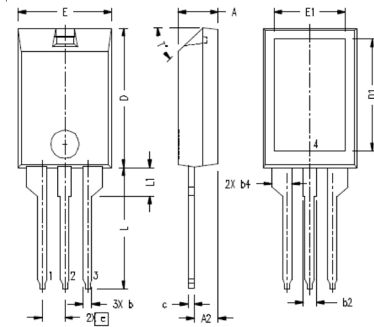
Symbol	Test Conditions ( $T_J = 25^\circ\text{C}$ unless otherwise specified)	Characteristic Values		
		Min.	Typ.	Max.
$BV_{DSS}$	$V_{GS} = 0 \text{ V}$ , $I_D = 250 \mu\text{A}$	500		V
$V_{GS(th)}$	$V_{DS} = V_{GS}$ , $I_D = 2.5 \text{ mA}$	3.0		5.5 V
$I_{GSS}$	$V_{GS} = \pm 30 \text{ V}$ , $V_{DS} = 0 \text{ V}$			$\pm 100 \text{ nA}$
$I_{DSS}$	$V_{DS} = V_{DSS}$ , $V_{GS} = 0 \text{ V}$ , $T_J = 125^\circ\text{C}$			5 $\mu\text{A}$ 50 $\mu\text{A}$
$R_{DS(on)}$	$V_{GS} = 10 \text{ V}$ , $I_D = I_T$ (Note 1) Pulse test, $t \leq 300 \mu\text{s}$ , duty cycle $d \leq 2 \%$			450 $\text{m}\Omega$

Symbol	Test Conditions	Characteristic Values ( $T_j = 25^\circ\text{C}$ unless otherwise specified)		
		Min.	Typ.	Max.
$g_{fs}$	$V_{DS} = 20\text{ V}; I_D = I_T$ , pulse test	9	16	S
$C_{iss}$ $C_{oss}$ $C_{rss}$	$V_{GS} = 0\text{ V}, V_{DS} = 25\text{ V}, f = 1\text{ MHz}$		2250	pF
			240	pF
			12	pF
$t_{d(on)}$ $t_r$ $t_{d(off)}$ $t_f$	$V_{GS} = 10\text{ V}, V_{DS} = 0.5 V_{DSS}, I_D = I_T$ $R_G = 10\ \Omega$ (External)		23	ns
			25	ns
			70	ns
			22	ns
$Q_{g(on)}$ $Q_{gs}$ $Q_{gd}$	$V_{GS} = 10\text{ V}, V_{DS} = 0.5 V_{DSS}, I_D = I_T$		43	nC
			15	nC
			12	nC
$R_{thJC}$ $R_{thCS}$			1.0	$^\circ\text{C/W}$
		0.21		$^\circ\text{C/W}$

Symbol	Test Conditions	Characteristic Values ( $T_j = 25^\circ\text{C}$ unless otherwise specified)		
		Min.	Typ.	Max.
$I_S$	$V_{GS} = 0\text{ V}$			16 A
$I_{SM}$	Repetitive			40 A
$V_{SD}$	$I_F = I_S, V_{GS} = 0\text{ V}$ , Pulse test, $t \leq 300\ \mu\text{s}$ , duty cycle $d \leq 2\%$			1.5 V
$t_{rr}$ $I_{RM}$ $Q_{RM}$	$I_F = 16\text{ A}, -di/dt = 100\text{ A}/\mu\text{s}$ $V_R = 100\text{ V}, V_{GS} = 0\text{ V}$			200 ns
			6	A
			0.6	$\mu\text{C}$

Note 1: Test Current  $I_T = 8\text{ A}$

ISOPLUS220™ (IXFC) Outline



Note:  
Bottom heatsink (Pin 4) is electrically isolated from Pin 1, 2, or 3.

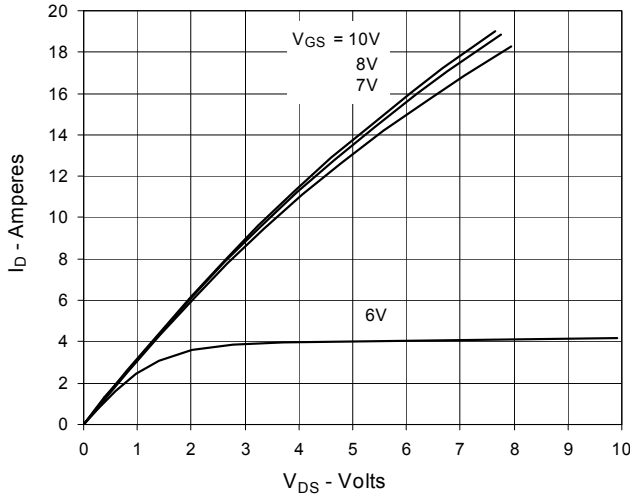
SYM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	.157	.197	4.00	5.00
A2	.098	.118	2.50	3.00
b	.035	.051	0.90	1.30
b2	.049	.065	1.25	1.65
b4	.093	.100	2.35	2.55
c	.028	.039	0.70	1.00
D	.591	.630	15.00	16.00
D1	.472	.512	12.00	13.00
E	.394	.433	10.00	11.00
E1	.295	.335	7.50	8.50
e	.100 BASIC		2.55 BASIC	
L	.512	.571	13.00	14.50
L1	.118	.138	3.00	3.50
T*			42.5°	47.5°

Ref: IXYS CO 0177 R0

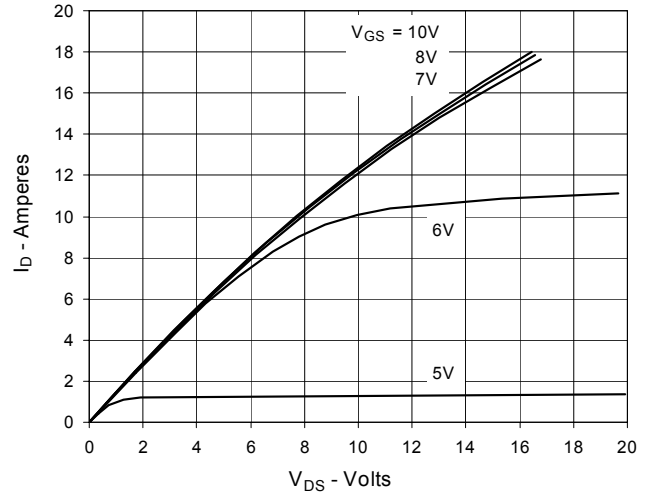
IXYS reserves the right to change limits, test conditions, and dimensions.

IXYS MOSFETs and IGBTs are covered by 4,835,592 4,931,844 5,049,961 5,237,481 6,162,665 6,404,065 B1 6,683,344 6,727,585  
 one or more of the following U.S. patents: 4,850,072 5,017,508 5,063,307 5,381,025 6,259,123 B1 6,534,343 6,710,405 B2 6,759,692  
 4,881,106 5,034,796 5,187,117 5,486,715 6,306,728 B1 6,583,505 6,710,463 6,771,478 B2

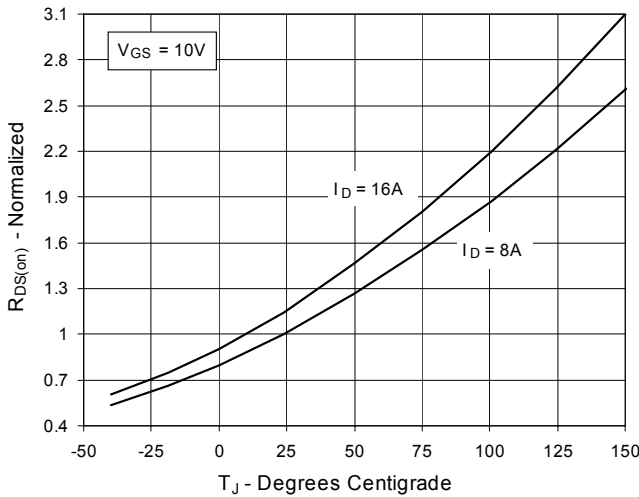
**Fig. 1. Output Characteristics @ 25°C**



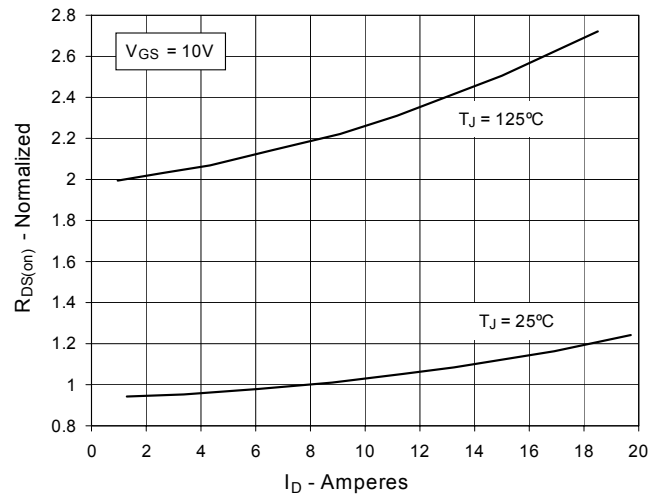
**Fig. 2. Output Characteristics @ 125°C**



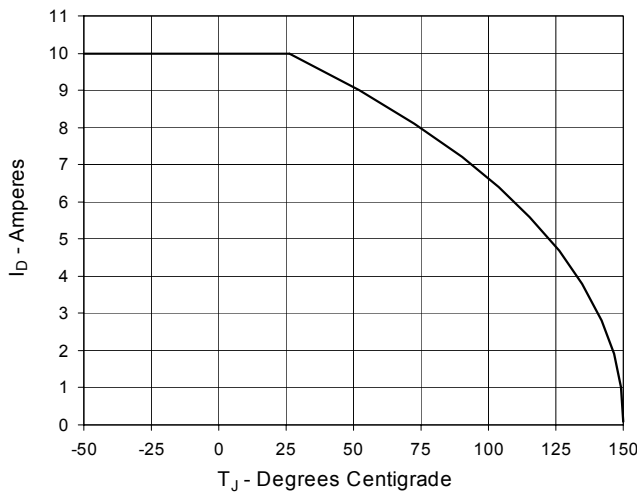
**Fig. 3.  $R_{DS(on)}$  Normalized to  $I_D = 8\text{A}$  vs. Junction Temperature**



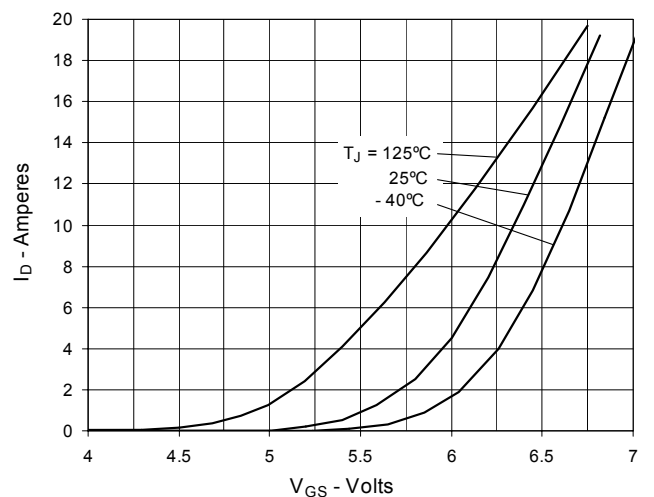
**Fig. 4.  $R_{DS(on)}$  Normalized to  $I_D = 8\text{A}$  vs. Drain Current**



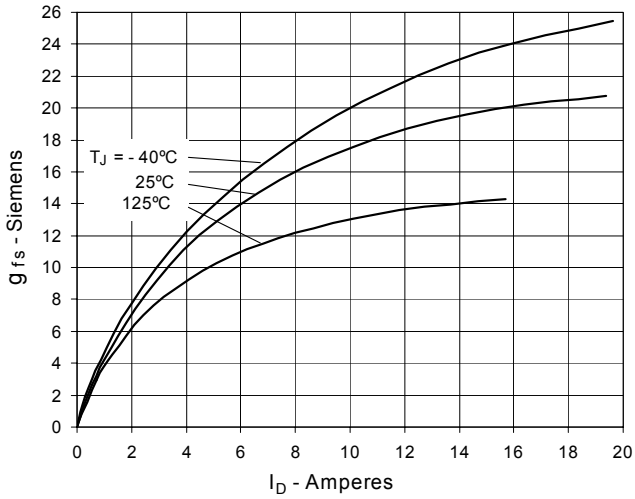
**Fig. 5. Maximum Drain Current vs. Case Temperature**



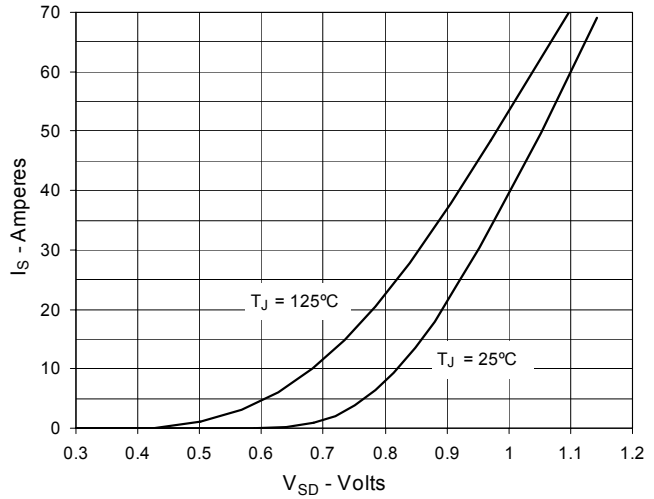
**Fig. 6. Input Admittance**



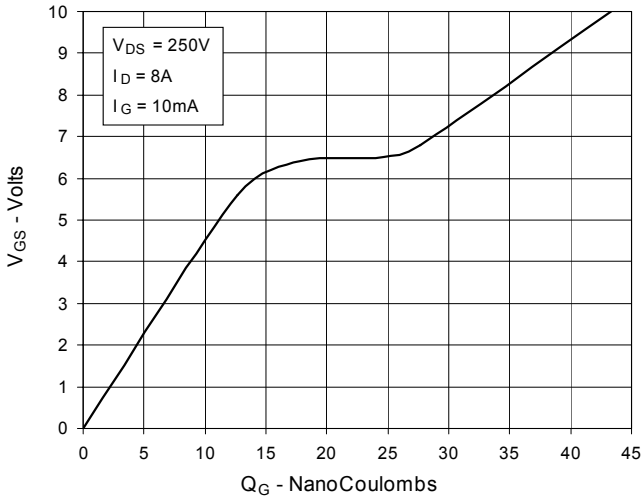
**Fig. 7. Transconductance**



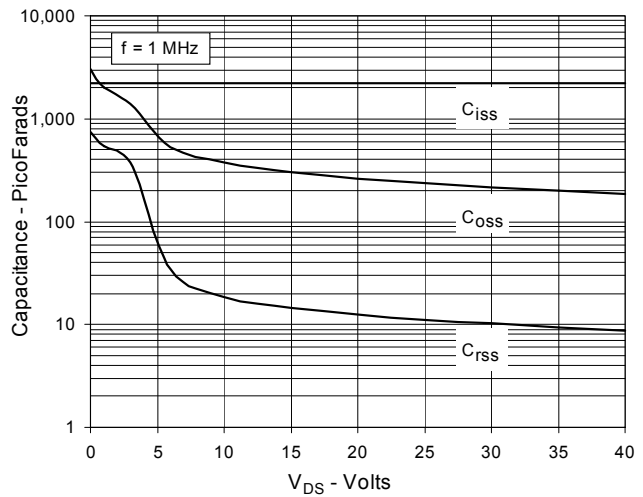
**Fig. 8. Forward Voltage Drop of Intrinsic Diode**



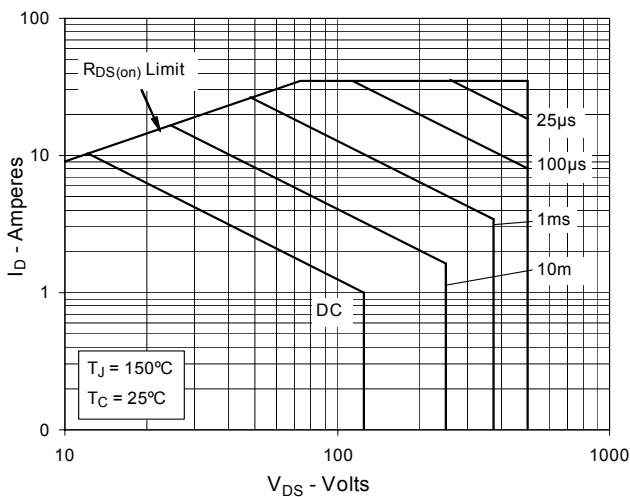
**Fig. 9. Gate Charge**



**Fig. 10. Capacitance**



**Fig. 11. Forward-Bias Safe Operating Area**



**Fig. 12. Maximum Transient Thermal Resistance**

